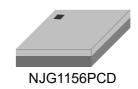
## **GPS Front-End Module**

#### GENERAL DESCRIPTION

The NJG1156PCD is a front-end module (FEM) designed for GPS applications. The NJG1156PCD offers high gain, low noise figure, high linearity and very high out-band rejection characteristics brought by included high performance pre- SAW filter, low noise amplifier (LNA) and post- SAW filter. The NJG1156PCD can be operated from 1.5V to 3.3V single voltage.

The NJG1156PCD offers very small mounting area by included two SAW filters, only two external components and very small HFFP10-CD package that is 2.5x2.5mm.

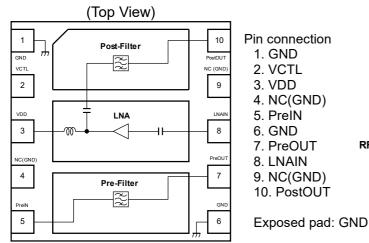




#### FEATURES

- Low supply voltage 1.8/ 2.8V typ. • Low current consumption 2.6/3.3mA typ. @V<sub>DD</sub>=1.8/ 2.8V, V<sub>CTL</sub>=1.8V 0.1µA typ. @V<sub>DD</sub>=1.8/ 2.8V, V<sub>CTL</sub>=0V (Stand-by mode) 17.5/18.5dB typ. @V<sub>DD</sub>=1.8/ 2.8V, V<sub>CTL</sub>=1.8V, f=1575MHz • High gain • Low noise figure 1.60/1.55dB typ. @V<sub>DD</sub>=1.8/ 2.8V, V<sub>CTL</sub>=1.8V, f=1575MHz • High out band rejection @f=704 to 915MHz, relative to 1575MHz 85dBc typ. 75dBc typ. @f=1710 to 1980MHz, relative to 1575MHz 78dBc typ. @f=1526 to 1536MHz, 1627 to 1680MHz,
- Small package size
- RoHS compliant and Halogen Free, MSL1

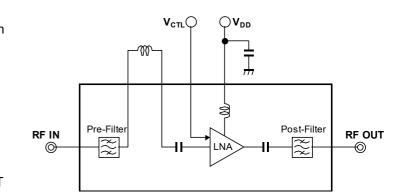
#### PIN CONFIGURATION



#### BLOCK DIAGRAM

relative to 1575MHz

HFFP10-CD: 2.5mmx2.5mmx0.63mm max.



#### ■ TRUTH TABLE

| <u>"H"=V<sub>CTL</sub>(H), "L"=V<sub>CTL</sub>(L)</u> |               |  |
|---|---------------|--|
| VCTL  | Mode          |  |
| Н   | Active mode   |  |
| L   | Stand-by mode |  |

Note: Specifications and description listed in this datasheet are subject to change without notice.

#### ■ ABSOLUTE MAXIMUM RATINGS

T<sub>a</sub>=+25°C, Z<sub>s</sub>=Z<sub>l</sub>=50Ω

|                       |                           |   | $T_{a} = 125 \text{ C}, 2$ | -s-Z -0032 |
|-----------------------|---------------------------|---|----------------------------|------------|
| PARAMETERS            | SYMBOL                    | CONDITIONS  | RATINGS                    | UNITS      |
| Supply voltage        | V <sub>DD</sub>           |   | 5.0                        | V          |
| Control voltage       | V <sub>CTL</sub>          |   | 5.0                        | V          |
| Input nowor           | P <sub>IN</sub> (inband)  | V <sub>DD</sub> =2.8V,<br>f=1575, 1597 to 1606MHz                           | +15                        | dBm        |
| Input power           | P <sub>IN</sub> (outband) | V <sub>DD</sub> =2.8V,<br>f=50 to 1460, 1710 to 4000MHz                     | +27                        | dBm        |
| Power dissipation     | PD                        | 4-layer FR4 PCB with through-hole<br>(101.5x114.5mm), T <sub>i</sub> =100°C | 510                        | mW         |
| Operating temperature | $T_{opr}$                 |   | -40 to +85                 | °C         |
| Storage temperature   | T <sub>stg</sub>          |   | -40 to +100                | °C         |

#### ■ ELECTRICAL CHARACTERISTICS 1 (DC)

|                        |                     |  | (General conditions: T <sub>a</sub> =+25°C) |     |      |       |
|------------------------|---------------------|--|---|-----|------|-------|
| PARAMETER              | SYMBOL              | CONDITIONS   | MIN   | TYP | MAX  | UNITS |
| Supply Voltage         | V <sub>DD</sub>     |  | 1.5   | -   | 3.3  | V     |
| Control Voltage (High) | V <sub>CTL(H)</sub> |  | 1.5   | 1.8 | 3.3  | V     |
| Control Voltage (Low)  | V <sub>CTL(L)</sub> |  | 0   | 0   | 0.3  | V     |
| Supply Current 1       | I <sub>DD1</sub>    | RF OFF,<br>V <sub>DD</sub> =2.8V, V <sub>CTL</sub> =1.8V | -   | 3.3 | 6.4  | mA    |
| Supply Current 2       | I <sub>DD2</sub>    | RF OFF,<br>V <sub>DD</sub> =1.8V, V <sub>CTL</sub> =1.8V | -   | 2.6 | 5.9  | mA    |
| Supply Current 3       | I <sub>DD3</sub>    | RF OFF,<br>V <sub>DD</sub> =2.8V, V <sub>CTL</sub> =0V   | -   | 0.1 | 5.0  | μA    |
| Supply Current 4       | I <sub>DD4</sub>    | RF OFF,<br>V <sub>DD</sub> =1.8V, V <sub>CTL</sub> =0V   | -   | 0.1 | 5.0  | μA    |
| Control Current        | I <sub>CTL</sub>    | V <sub>CTL</sub> =1.8V                                   | -   | 5.0 | 15.0 | μA    |

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## ■ ELECTRICAL CHARACTERISTICS 2 (RF)

| General conditions: V <sub>DD</sub> =2.8V, V <sub>CTL=</sub> 1.8V, f <sub>RF</sub> =1575MHz, T <sub>a</sub> =+25°C, Z <sub>s</sub> =Z <sub>I</sub> =50Ω, with application circuit |                     |   |      |       |      |       |
|---|---------------------|---|------|-------|------|-------|
| PARAMETER   | SYMBOL              | CONDITIONS  | MIN  | TYP   | MAX  | UNITS |
| Small Signal Gain1  | Gain1               | f=1575MHz, Exclude PCB,<br>Connector Losses (0.19dB)                                    | 17.3 | 18.5  | -    | dB    |
| Noise Figure1   | NF1                 | f=1575MHz, Exclude PCB,<br>Connector Losses (0.09dB)                                    | -    | 1.55  | 2.05 | dB    |
| Input Power at 1dB Gain<br>Compression Point 1  | P-1dB(IN)1          | f=1575MHz   | -    | -15.0 | -    | dBm   |
| Input 3rd Order<br>Intercept Point 1  | IIP3_1              | f1=1575MHz, f2=f1+/-1MHz,<br>Pin=-30dBm   | -    | -4.0  | -    | dBm   |
| Out of Band<br>Input 2nd Order<br>Intercept Point 1   | IIP2_OB1            | f1=824.6MHz at +15dBm,<br>f2=2400MHz at +15dBm,<br>fmeas=1575.4MHz                      | -    | +87   | -    | dBm   |
| Out of Band<br>Input 3rd Order<br>Intercept Point 1   | IIP3_OB1            | f1=1712.7MHz at +15dBm,<br>f2=1850MHz at +15dBm,<br>fmeas=1575.4MHz                     | -    | +55   | -    | dBm   |
| 700MHz Harmonics1   | 2fo1                | Input jammer tone:<br>787.76MHz at +15dBm<br>Measure the harmonic tone<br>at 1575.52MHz | -    | -43   | -    | dBm   |
| Out-of-Band<br>Input Power 1dB<br>Compression 1   | P-1dB(IN)<br>_OB1-1 | fjam=900MHz,<br>fmeas=1575MHz<br>at Pin=-40dBm  | -    | +24   | -    | dBm   |
|   | P-1dB(IN)<br>_OB1-2 | fjam=1710MHz,<br>fmeas=1575MHz<br>at Pin=-40dBm   | -    | +24   | -    | dBm   |
| Low Band Rejection 1  | BR_L1               | f=704 to 915MHz,<br>relative to 1575MHz   | 75   | 85    | -    | dBc   |
| High Band Rejection 1   | BR_H1               | f=1710 to 1980MHz,<br>relative to 1575MHz   | 65   | 75    | -    | dBc   |
| WLAN Band Rejection 1   | BR_W1               | f=2400 to 2500MHz,<br>relative to 1575MHz   | 60   | 72    | -    | dBc   |
| LS Rejection1   | BR_LS1              | f=1526 to 1536MHz,<br>1627 to 1680MHz,<br>relative to 1575MHz                           | -    | 78    |      | dBc   |
| RF IN Return Loss1  | RLi1                | f=1575MHz   | -    | 6.5   | -    | dB    |
| RF OUT Return Loss1   | RLo1                | f=1575MHz   | -    | 20    | -    | dB    |

## ■ ELECTRICAL CHARACTERISTICS 3 (RF)

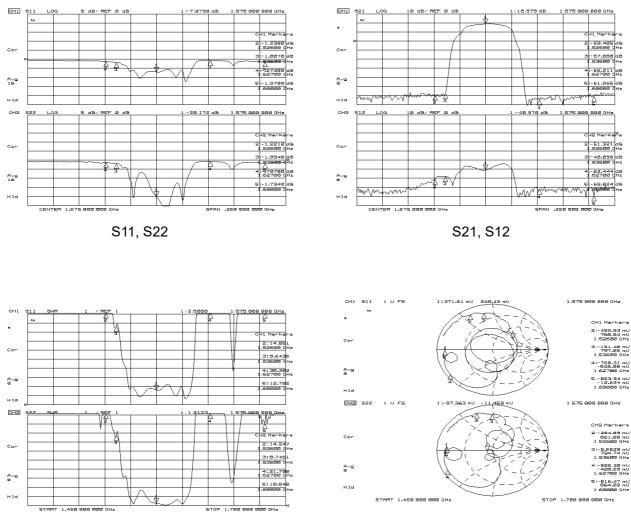
| General conditions: V <sub>DD</sub> =1.8V, V <sub>CTL=</sub> 1.8V, f <sub>RF</sub> =1575MHz, T₂=+25°C, Z₅=ZI=50Ω, with application circuit |                     |   |      |       |     |       |
|--|---------------------|---|------|-------|-----|-------|
| PARAMETER  | SYMBOL              | CONDITIONS  | MIN  | TYP   | MAX | UNITS |
| Small Signal Gain2   | Gain2               | f=1575MHz, Exclude PCB,<br>Connector Losses (0.19dB)                                    | 15.8 | 17.5  | -   | dB    |
| Noise Figure2  | NF2                 | f=1575MHz, Exclude PCB,<br>Connector Losses (0.09dB)                                    | -    | 1.6   | 2.2 | dB    |
| Input Power at 1dB Gain<br>Compression Point 2   | P-1dB(IN)2          | f=1575MHz   | -    | -17.0 | -   | dBm   |
| Input 3rd Order<br>Intercept Point 2   | IIP3_2              | f1=1575MHz, f2=f1+/-1MHz,<br>Pin=-30dBm   | -    | -6.0  | -   | dBm   |
| Out of Band<br>Input 2nd Order<br>Intercept Point 2  | IIP2_OB2            | f1=824.6MHz at +15dBm,<br>f2=2400MHz at +15dBm,<br>fmeas=1575.4MHz                      | -    | +87   | -   | dBm   |
| Out of Band<br>Input 3rd Order<br>Intercept Point 2  | IIP3_OB2            | f1=1712.7MHz at +15dBm,<br>f2=1850MHz at +15dBm,<br>fmeas=1575.4MHz                     | -    | +50   | -   | dBm   |
| 700MHz Harmonics2  | 2fo2                | Input jammer tone:<br>787.76MHz at +15dBm<br>Measure the harmonic tone<br>at 1575.52MHz | -    | -43   | -   | dBm   |
| Out-of-Band<br>Input Power 1dB<br>Compression 2  | P-1dB(IN)<br>_OB2-1 | fjam=900MHz,<br>fmeas=1575MHz<br>at Pin=-40dBm  | -    | +24   | -   | dBm   |
|  | P-1dB(IN)<br>_OB2-2 | fjam=1710MHz,<br>fmeas=1575MHz<br>at Pin=-40dBm   | -    | +24   | -   | dBm   |
| Low Band Rejection 2   | BR_L2               | f=704 to 915MHz,<br>relative to 1575MHz   | -    | 85    | -   | dBc   |
| High Band Rejection 2  | BR_H2               | f=1710 to 1980MHz,<br>relative to 1575MHz   | -    | 75    | -   | dBc   |
| WLAN Band Rejection 2  | BR_W2               | f=2400 to 2500MHz,<br>relative to 1575MHz   | -    | 72    | -   | dBc   |
| LS Rejection2  | BR_LS2              | f=1526 to 1536MHz,<br>1627 to 1680MHz,<br>relative to 1575MHz                           | -    | 78    |     | dBc   |
| RF IN Return Loss2   | RLi2                | f=1575MHz   | -    | 6.5   | -   | dB    |
| RF OUT Return Loss2  | RLo2                | f=1575MHz   | -    | 17    | -   | dB    |

#### ■ TERMINAL INFORMATION

| No.            | SYMBOL  | DESCRIPTION  |
|----------------|---------|--|
| 1              | GND     | Ground terminal. This terminal should be connected to the ground plane as close as possible for excellent RF performance.                                      |
| 2              | VCTL    | Control voltage terminal.  |
| 3              | VDD     | Supply voltage terminal. Please connect bypass capacitor C1 with ground as close as possible.  |
| 4              | NC(GND) | No connected terminal. This terminal is not connected with internal circuit.<br>Please connect to the PCB ground Plane.  |
| 5              | PrelN   | RF input terminal. This terminal connects to input of pre-SAW filter.  |
| 6              | GND     | Ground terminal. This terminal should be connected to the ground plane as close as possible for excellent RF performance.                                      |
| 7              | PreOUT  | Pre-SAW filter output terminal. This terminal connects to LNAIN with L1.   |
| 8              | LNAIN   | RF input terminal. This terminal requires only a matching inductor L1, and does not require DC blocking capacitor because of integrated capacitor.             |
| 9              | NC(GND) | No connected terminal. This terminal is not connected with internal circuit.<br>Please connect to the PCB ground Plane.  |
| 10             | PostOUT | RF output terminal. This terminal requires no DC blocking capacitor since this terminal has integrated SAW that also works as DC blocking capacitor in nature. |
| Exposed<br>Pad | GND     | Ground terminal.   |

\_

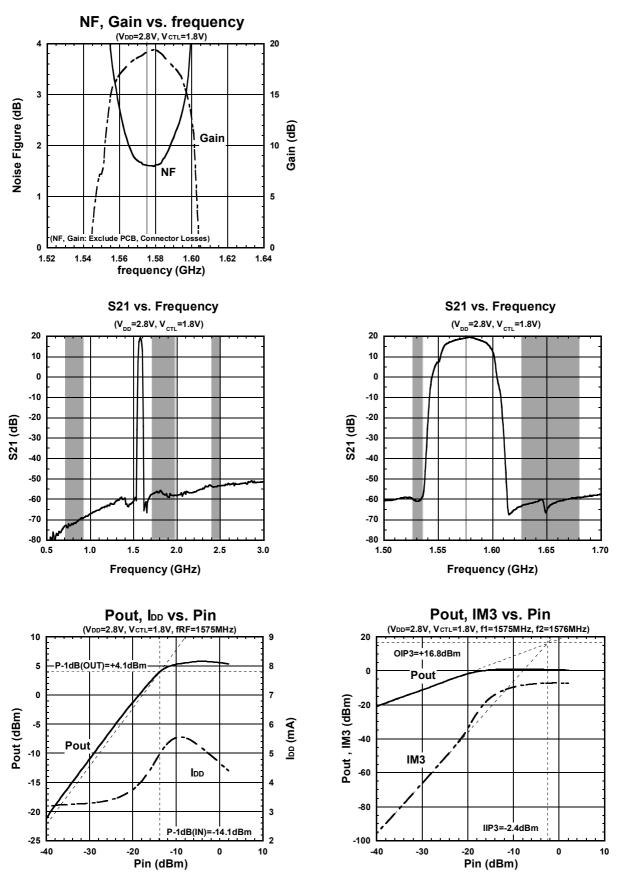
Conditions: V\_DD=2.8V, V\_CTL=1.8V, Ta=25°C, Z\_s=Z\_I=50\Omega, with application circuit



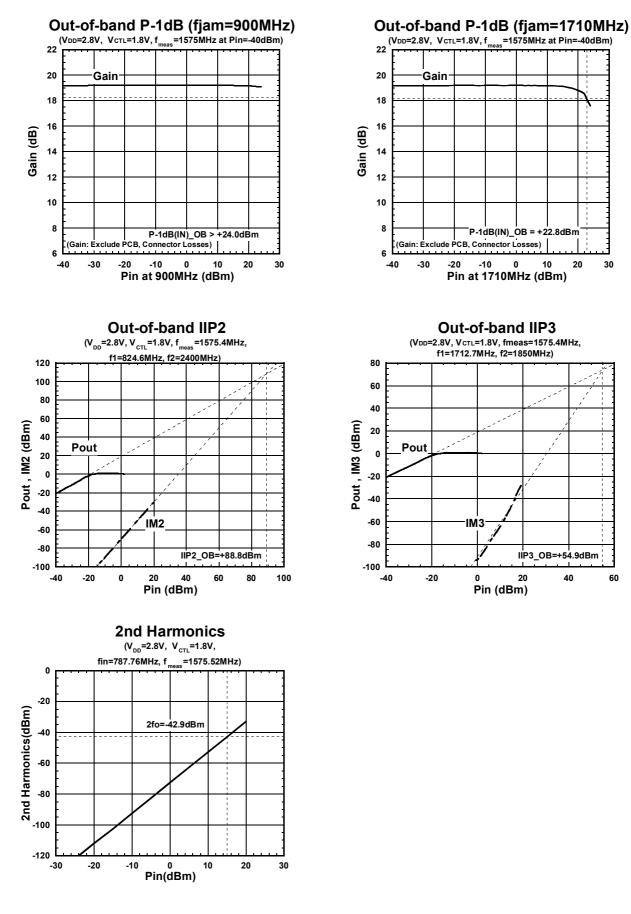
VSWR

Zin, Zout

Conditions:  $V_{DD}$ =2.8V,  $V_{CTL}$ =1.8V, Ta=25°C,  $Z_s$ = $Z_l$ =50 $\Omega$ , with application circuit



Conditions:  $V_{DD}$ =2.8V,  $V_{CTL}$ =1.8V, Ta=25°C,  $Z_s$ = $Z_I$ =50 $\Omega$ , with application circuit



Nen -61.021

-59.05

-64.671 15

69.78

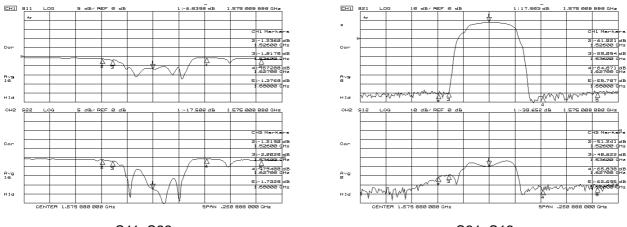
2 Mark

-51.241 de

48.622 dE

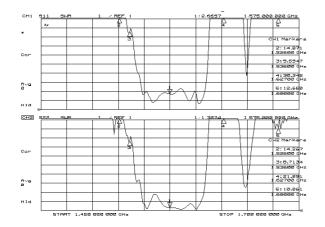
#### ELECTRICAL CHARACTERISTICS

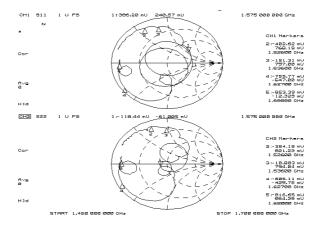
Conditions:  $V_{DD}$ =1.8V,  $V_{CTL}$ =1.8V, Ta=25°C,  $Z_s$ = $Z_l$ =50 $\Omega$ , with application circuit



S11, S22



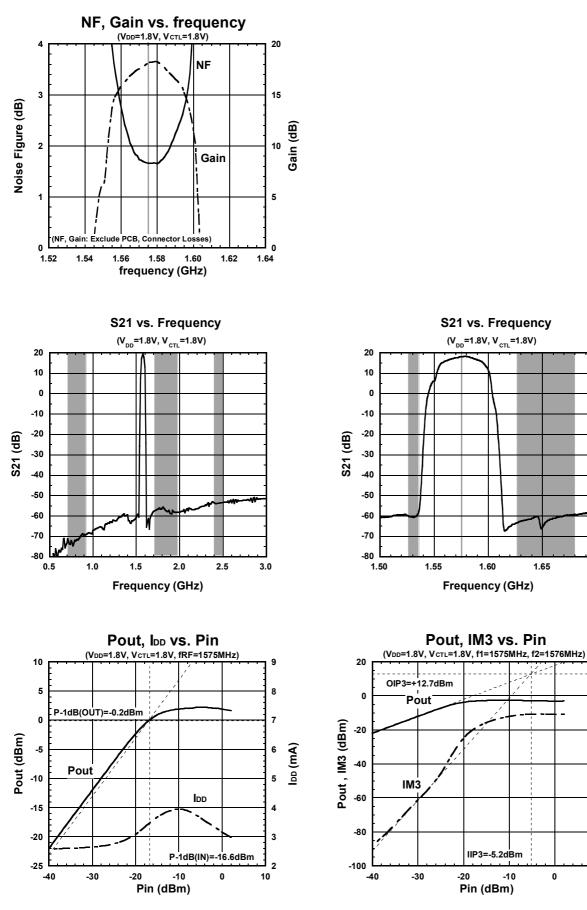




VSWR

Zin, Zout

Conditions:  $V_{DD}$ =1.8V,  $V_{CTL}$ =1.8V, Ta=25°C,  $Z_s$ = $Z_I$ =50 $\Omega$ , with application circuit

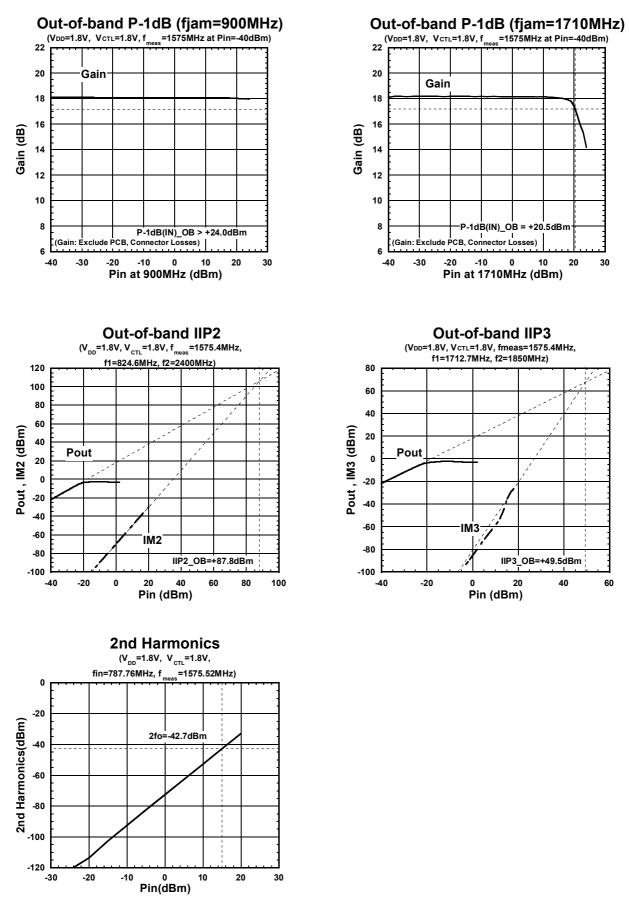


Nisshinbo Micro Devices Inc.

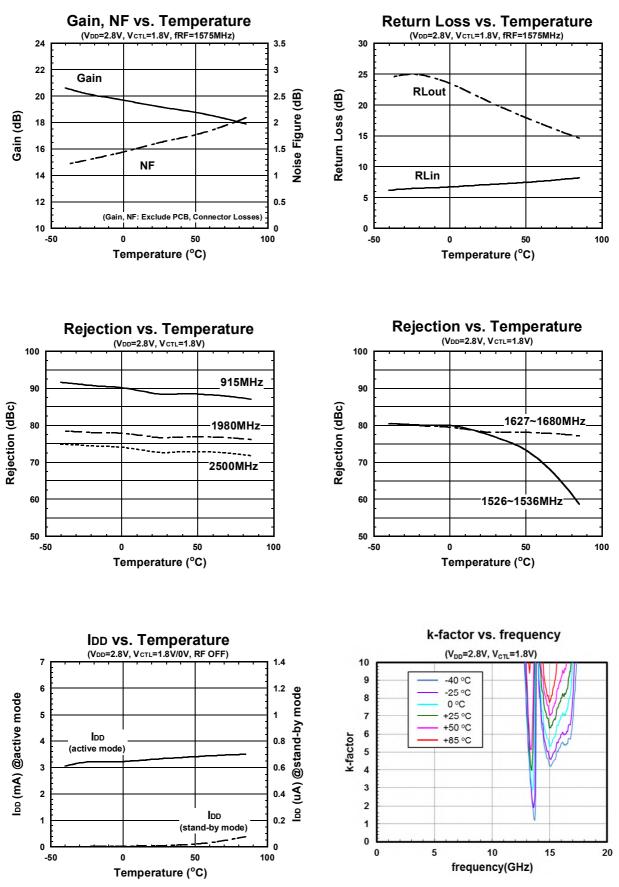
1.70

10

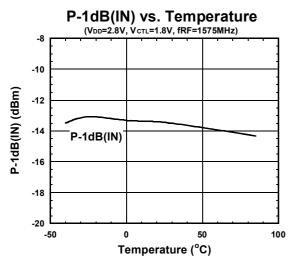
Conditions:  $V_{DD}$ =1.8V,  $V_{CTL}$ =1.8V, Ta=25°C,  $Z_s$ = $Z_I$ =50 $\Omega$ , with application circuit

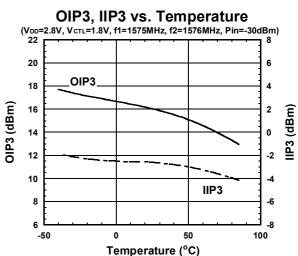


Conditions:  $V_{DD}$ =2.8V,  $V_{CTL}$ =1.8V,  $Z_s$ = $Z_l$ =50 $\Omega$ , with application circuit



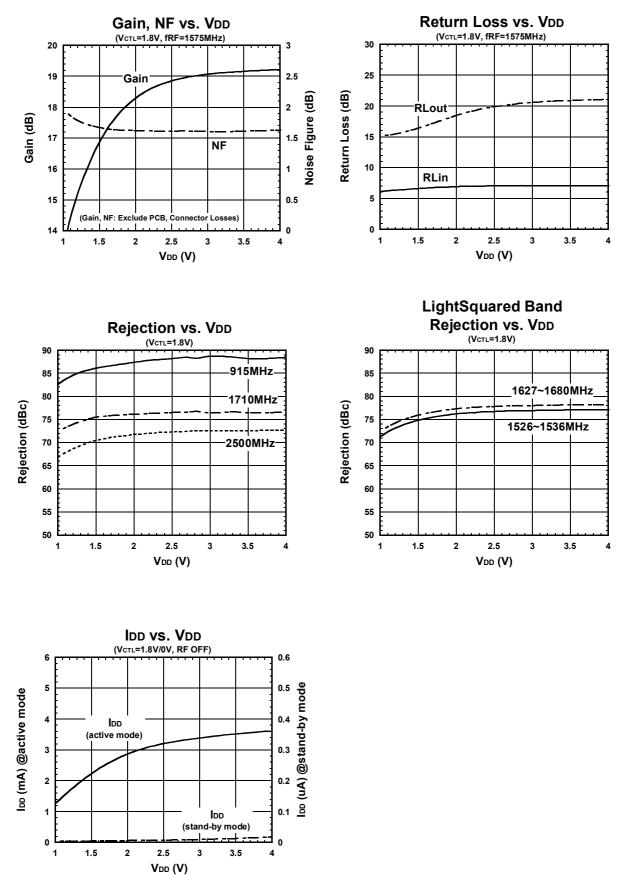
Conditions:  $V_{DD}$ =2.8V,  $V_{CTL}$ =1.8V,  $Z_s$ = $Z_l$ =50 $\Omega$ , with application circuit



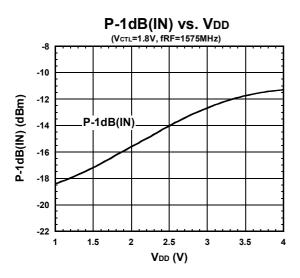


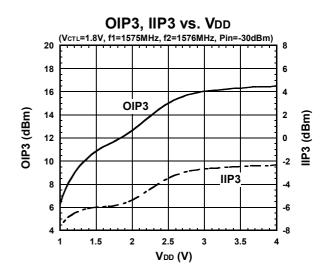
Out-of-band IIP2 vs. Temperature Out-of-band IIP3 vs. Temperature (VDD=2.8V, VCTL=1.8V, fmeas=1575.4MHz, f1=824.6MHz at Pin=+15dBm, f2=2400MHz at Pin=+15dBm) 100 (VDD=2.8V, VCTL=1.8V, fmeas=1575MHz, f1=1713MHz at Pin=+15dBm, f2=1851MHz at Pin=+15dBm) 80 90 Out-of-band IIP2 (dBm) Out-of-band IIP3 (dBm) 70 IIP2 OB 80 60 70 IIP3\_OB 60 50 50 40 40 30 30 -50 0 50 100 -50 0 50 100 Temperature (°C) Temperature (°C) Out of band P-1dB vs. Temperature 2nd Harmonics vs. Temperature (VDD=2.8V, VCTL=1.8V, fRF=1575MHz) (VDD=2.8V, VCTL=1.8V, fRF=787.76MHz) 0 30 Out of band P-1dB (dBm) 25 2nd Harmonics (dBm) -10 fjam=1710MHz 20 -20 15 -30 10 2fo -40 5 \* P-1dB(fjam=900MHz) is over +24dBm -50 0 -50 100 0 50 100 0 50 -50 Temperature (°C) Temperature (°C)

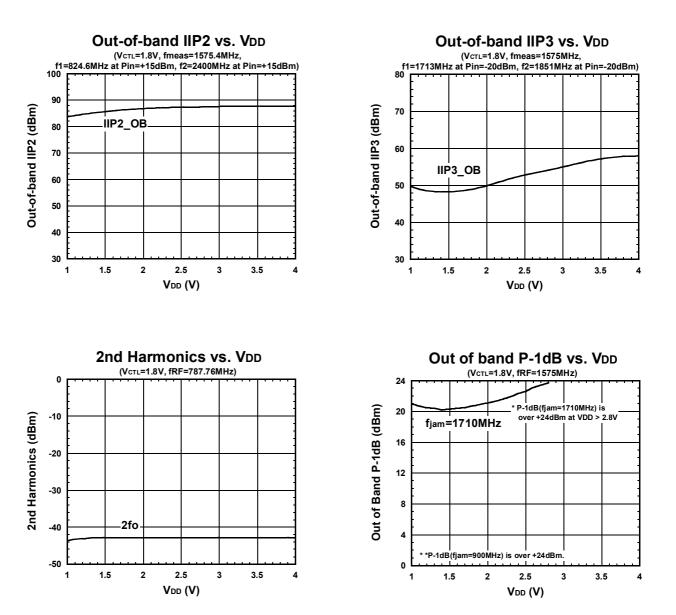
Conditions: V<sub>CTL</sub>=1.8V, Ta=25°C,  $Z_s=Z_l=50\Omega$ , with application circuit



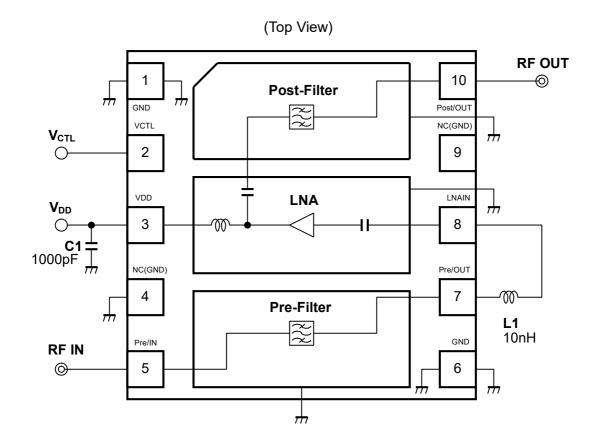
Conditions: V<sub>CTL</sub>=1.8V, Ta=25°C,  $Z_s=Z_l=50\Omega$ , with application circuit







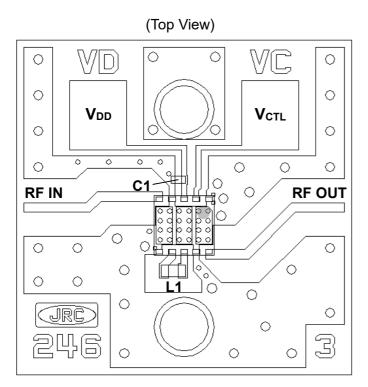
## ■ APPLICATION CIRCUIT



| Parts li | ist |
|----------|-----|
|----------|-----|

| Parts ID | Manufacture                   |
|----------|-------------------------------|
| L1       | LQW15AN_00 Series<br>(MURATA) |
| C1       | GRM03 Series<br>(MURATA)      |

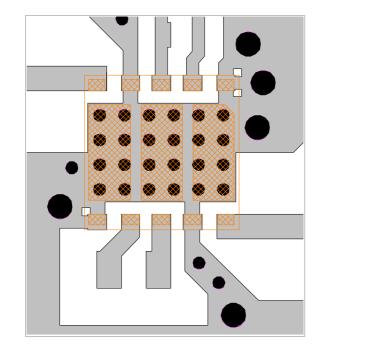
#### Evaluation board

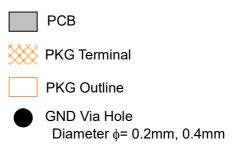


PCB

Substrate: FR-4 Thickness: 0.2mm Microstrip line width: 0.4mm ( $Z_0=50\Omega$ ) Size: 14.0mm x 14.0mm

#### <PCB LAYOUT GUIDELINE>





#### PRECAUTIONS

• Please layout ground pattern under this FEM in order not to couple with RFIN and RFOUT terminal.

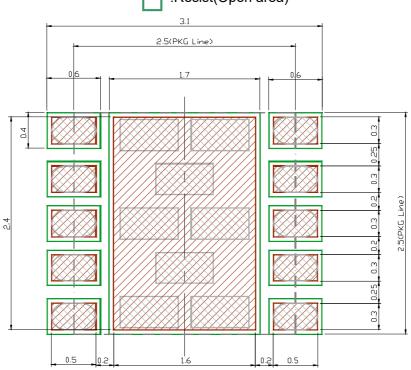
• All external parts should be placed as close as possible to the FEM.

• For good RF performance, all GND terminals must be connected to PCB ground plane of substrate, and via-holes for GND should be placed near the FEM.

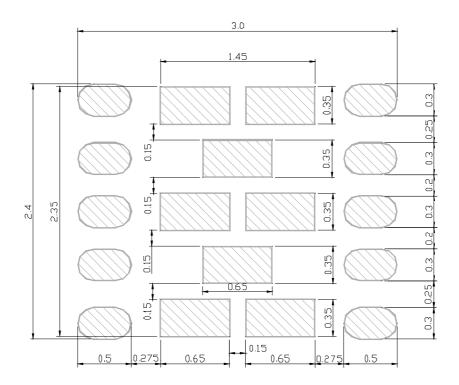
## ■ RECOMMENDED FOOTPRINT PATTERN (HFFP10-CD PACKAGE) <Reference>

PKG : 2.5mm x 2.5mm

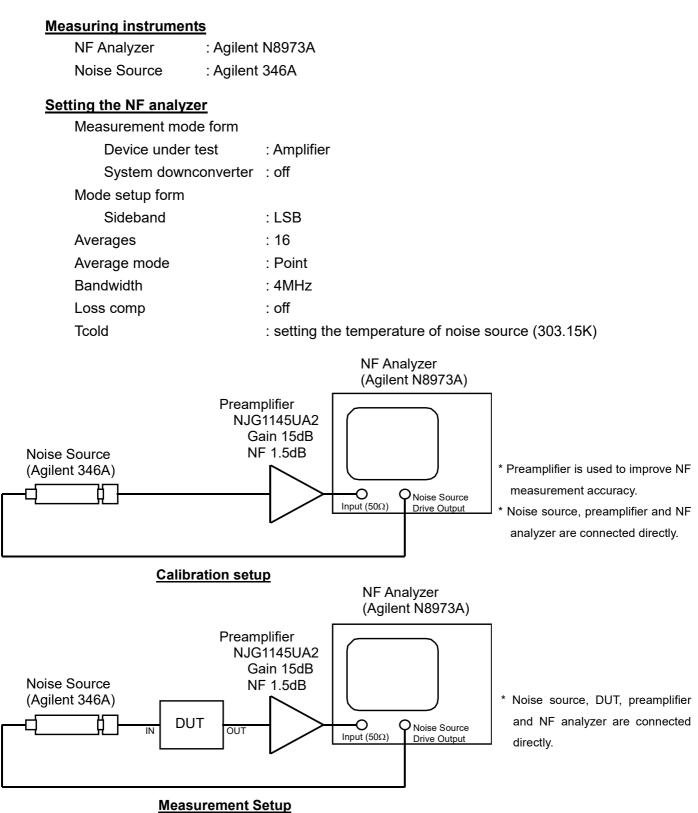
: Land :Mask (Open area) \*Metal mask thickness : 100μm :Resist(Open area)



#### Metal MASK Detail

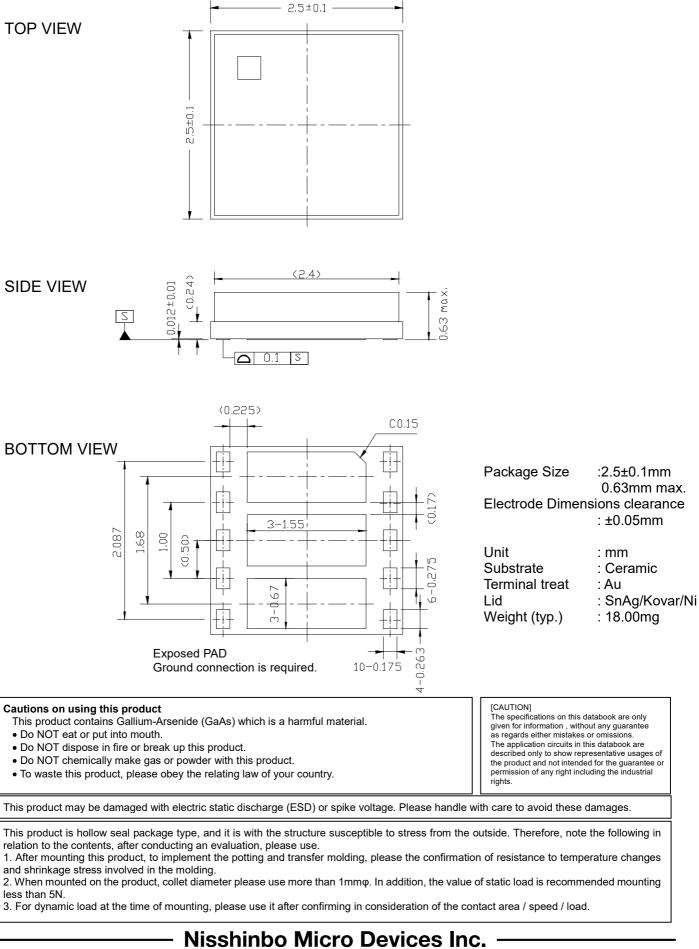


#### ■ NOISE FIGURE MEASUREMENT BLOCK DIAGRAM



# NJG1156PCD

#### ■ PACKAGE OUTLINE (HFFP10-CD)



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  - Aerospace Equipment
  - Equipment Used in the Deep Sea
  - Power Generator Control Equipment (nuclear, steam, hydraulic, etc.)
  - Life Maintenance Medical Equipment
  - Fire Alarms / Intruder Detectors
  - Vehicle Control Equipment (automotive, airplane, railroad, ship, etc.)
  - Various Safety Devices
  - Traffic control system
  - Combustion equipment

In case your company desires to use this product for any applications other than general electronic equipment mentioned above, make sure to contact our company in advance. Note that the important requirements mentioned in this section are not applicable to cases where operation requirements such as application conditions are confirmed by our company in writing after consultation with your company.

- 6. We are making our continuous effort to improve the quality and reliability of our products, but electronic device products are likely to fail with certain probability. In order to prevent any injury to persons or damages to property resulting from such failure, customers should be careful enough to incorporate safety measures in their design, such as redundancy feature, fire containment feature and fail-safe feature. We do not assume any liability or responsibility for any loss or damage arising from misuse or inappropriate use of the products.
- 7. The products have been designed and tested to function within controlled environmental conditions. Do not use products under conditions that deviate from methods or applications specified in this datasheet. Failure to employ the products in the proper applications can lead to deterioration, destruction or failure of the products. We shall not be responsible for any bodily injury, fires or accident, property damage or any consequential damages resulting from misuse or misapplication of the products.
- 8. Quality Warranty
  - 8-1. Quality Warranty Period

In the case of a product purchased through an authorized distributor or directly from us, the warranty period for this product shall be one (1) year after delivery to your company. For defective products that occurred during this period, we will take the quality warranty measures described in section 8-2. However, if there is an agreement on the warranty period in the basic transaction agreement, quality assurance agreement, delivery specifications, etc., it shall be followed.

8-2. Quality Warranty Remedies

When it has been proved defective due to manufacturing factors as a result of defect analysis by us, we will either deliver a substitute for the defective product or refund the purchase price of the defective product.

- Note that such delivery or refund is sole and exclusive remedies to your company for the defective product.
- 8-3. Remedies after Quality Warranty Period

With respect to any defect of this product found after the quality warranty period, the defect will be analyzed by us. On the basis of the defect analysis results, the scope and amounts of damage shall be determined by mutual agreement of both parties. Then we will deal with upper limit in Section 8-2. This provision is not intended to limit any legal rights of your company.

- 9. Anti-radiation design is not implemented in the products described in this document.
- 10. The X-ray exposure can influence functions and characteristics of the products. Confirm the product functions and characteristics in the evaluation stage.
- 11. Warning for handling Gallium and Arsenic (GaAs) products (Applying to GaAs MMIC, Photo Reflector). These products use Gallium (Ga) and Arsenic (As) which are specified as poisonous chemicals by law. For the prevention of a hazard, do not burn, destroy, or process chemically to make them as gas or power. When the product is disposed of, please follow the related regulation and do not mix this with general industrial waste or household waste.
- 12. Front end module product is hollow seal package type, and it is with the structure susceptible to stress from the outside. Therefore, note the following in relation to the contents, after conducting an evaluation. please use.
  - 12-1. After mounting this product, to implement the potting and transfer molding, please the confirmation of resistance to temperature changes and shrinkage stress involved in the molding.
  - 12-2. When mounted on the product, collet diameter please use more than 1mmφ. In addition, the value of static load is recommended mounting less than 5N.
  - 12-3. For dynamic load at the time of mounting. please use it after confirming in consideration of the contact area /speed /load.
- 13. Please contact our sales representatives should you have any questions or comments concerning the products or the technical information.



Nisshinbo Micro Devices Inc.

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